

MN101D10F , MN101D10G

Type	MN101D10F	MN101D10G
ROM (x8-bit)	96 K	128K
RAM (x8-bit)	2.5 K	3.5 K
Package	QFP100-P-1818B *Lead-free	
Minimum Instruction Execution Time	With main clock operated 0.1397 μ s (at 4.0 V to 5.5 V, 14.32 MHz) 71.5 μ s (at 2.7 V to 5.5 V fixed to 14.32 MHz internal frequency division) When sub-clock operated 61 μ s (at 2.5 V to 5.5 V, 32.768 kHz)	
Interrupts	• RESET • Runaway • External 0 • External 1 • External 2 • External 3 • External 4 • Timer 0 • Timer 1 • Timer 2 • Timer 3 • Timer 6 • Capstan FG • Control • HSW • Cylinder(Drum) FG • Servo V-sync • Synchronous output • OSD • XDS • Serial 0 • Serial 1 • Serial 2 • PWM 4 • OSDV-sync	
Timer Counter	Timer counter 0: 8-bit $\times$ 1 (timer function) Clock source 1/4, 1/16 of system clock frequency Interrupt source overflow of timer counter 0 Timer counter 1: 8-bit $\times$ 1 (timer function, linear timer counter function) Clock source 1/4 of system clock frequency; CTL signal Interrupt source overflow of timer counter 1 Timer counter 2: 16-bit $\times$ 1 (timer function, input capture, duty judgment of CTL signal(VISS/VASS detection function), generation of remote control output carrier frequency) Clock source 1/4, 1/16, 1/24 of system clock frequency Interrupt source overflow of timer counter 2; input of CTL specified edge; underflow of timer 2 shift register 4-bit counter; coincidence of timer 2 shift register with timer 2 shift register compare register Timer counter 3: 16-bit $\times$ 1 (timer function, generation of serial transmission clock) Clock source 1/4, 1/16 of system clock frequency Interrupt source overflow of timer counter 3 Timer counter 5: 19-bit $\times$ 1 (watchdog, stable oscillation waiting function) Clock source system clock Watchdog interrupt source .. 1/2 ¹⁶ , 1/2 ¹⁹ of timer counter 5 frequency Clear by stable oscillation .. after 256 counts by timer counter 5 (2 ¹⁸ counts of OSC oscillation clock) Timer counter 6: 16-bit $\times$ 1 (clock function [max. 2 s]) Clock source 1/512 of OSC oscillation clock frequency; XI oscillation clock; 1/8, 1/128 of system clock frequency Interrupt source 1/2 ¹³ , 1/2 ¹⁴ , 1/2 ¹⁵ overflow of timer counter 6	
Serial Interface	Serial 0: 8-bit $\times$ 1 (synchronous type) (transfer direction of MSB/LSB selectable, start condition function) Clock source 1/8, 1/16, 1/32, 1/64, 1/128, 1/256 of system clock frequency; NSBT0 pin input Serial 1: 8-bit $\times$ 1 (synchronous type/remote control transmission) (transfer direction of MSB/LSB selectable, start condition function) Clock source 1/8, 1/16, 1/32, 1/64, 1/128, 1/256 of system clock frequency; 2-division timer 3 output; NSBT1 pin input Remote control clock 2-division timer 3 output Serial 2: 8-bit $\times$ 1 (I ² C) (master transmission/reception, slave transmission/reception) Clock source 1/144 to 1/252 of system clock; SCK pin input	

OSD				Display mode	:	menu(internal synchronized) display, superimpose(externally synchronized) display	
				Applicable broadcasting system	:	NTSC, PAL, PAL-M, PAL-N	
				Screen configuration	:	24 characters × 2n rows (n = 1 to 6)	
				Character type	:	max. 256 character types (variable, include special characters)	
				Character size	:	12 × 18 dots (vertical direction: 1 dot for 2H at not enlargement)	
				Enlarged characters	:	each × 2 settings in horizontal and vertical	
				Character interpolation	:	none	
				Line background color	:	8-hue settable in the row unit at menu display	
				Line background intensity	:	8 gradations settable in the row unit	
				Screen background color:	:	8-huesettable at menu display	
				Character color	:	white	
				Character intensity	:	8 gradations settable in the row unit	
				Border function	:	1-dot border in 8 directions	
				Border brightness	:	4 gradations settable in the row unit	
				Blinking	:	none (covered by software)	
				Inverted character	:	settable in the character unit	
				Halftone	:	none	
				Input	:	composite video signal input (output level: 1 V[p-p] / 2 V[p-p])	
				Clamp method	:	sync tip clamp, clamp level in 4 levels	
				Output	:	composite video output	
				Measure against image fluctuation	:	built-in AFC circuit	
				Dot clock	:	1/2 of OSC oscillation clock (automatic phase adjustment)	
				MESECAM compatibility	:	Subcarrier leak function for superimpose display	
XDS				Built-in U.S. closed caption data slicer (optional 1 line data can be extracted.)			
ROM Correction				Correcting address designation: up to 3 addresses possible Correction method: correction program being saved in internal RAM			
I/O Pins	I/O	76	• Common use: 56				
	Input	1	• Common use: 1				
A/D Inputs				8-bit × 12-ch. (without S/H)			
PWM				13-bit × 2-ch. (at repetition cycle 572 μs at 14.32 MHz), 8-bit × 1-ch. (at repetition cycle 35.7 μs, 0.572 ms, 1.14 ms, 2.29 ms at 14.32 MHz)			
ICR				16-bit × 2-ch.(Speed system), 18-bit × 4-ch.(Phase system)			
OCR				16-bit × 3 (Synchronous output × 2, Rec CTL × 1)			
Special Ports				3-state output (PTO) VLP pin; CTL input;Capstan FG input; Cylinder(Drum) PG/FG inputs; HSW output; Head amp/ Rotary outputs; built-in FG amp; output of 1/4 OSC oscillation clock (1 V[p-p])			
Notes							

See the next page for electrical characteristics, pin assignment and support tool.

■ Electrical Characteristics

Supply current

Parameter	Symbol	Condition	Limit			Unit
			min	typ	max	
Operating supply current	IDD1	14.32 MHz operation without load, VDD = 5 V		50	100	mA
	IDD2	1/1024 of 14.32 MHz operation without load, VDD = 2.7 V		2	5	mA
	IDD3	Stop of 14.32 MHz oscillation, VDD = 2.7 V 32 kHz oscillation operation without load		50	100	μA
Supply current at STOP	IDSP	Stop of oscillation without load, VDD = 5 V, Ta = 55 °C			10	μA
Supply current at HALT	IDHT0	14.32 MHz oscillation without load, VDD = 5 V		5	15	mA
	IDHT1	Stop of 14.32 MHz oscillation, VDD = 2.7 V 32 kHz oscillation operation without load		5	20	μA

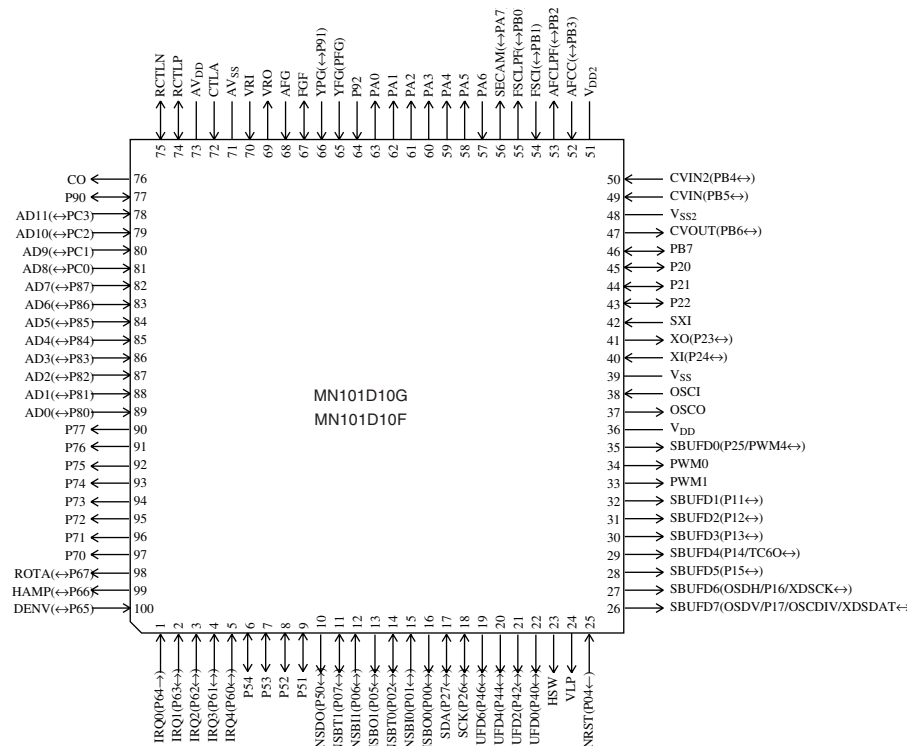
(Ta = 25 °C ± 2 °C, VSS = 0 V)

A/D Converter Performance

Parameter	Symbol	Condition	Limit			Unit
			min	typ	max	
Conversion relative error	ΔNLAD				± 3	LSB
A/D Conversion Time	tAD	fosc = 14.32 MHz		8		μs
Analog Input Voltage					5	V

(Ta = 25 °C ± 2 °C, VDD = 5.0 V, VSS = 0 V)

Pin Assignment



QFP100-P-1818B *Lead-free

Support Tool

In-circuit Emulator	PX-ICE101C / D + PX-PRB101D10-QFP100-P-1818B-CN-M
Flash Memory Built-in Type	Type MN101DF10GAF [ES (Engineering Sample) available]
	ROM (× 8-bit) 128 K
	RAM (× 8-bit) 4 K
	Minimum instruction execution time 0.1397 μs (at 4.0 V to 5.5 V, 14.32 MHz) 71.5 μs (at 2.7 V to 5.5 V, fixed to 14.32 MHz internal division) 61 μs (at 2.5 V to 5.5 V, 32.768 kHz)
	Package QFP100-P-1818B *Lead-free

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